1.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER
PowerDI323

Features

- Guard Ring Die Construction for Transient Protection
- High Surge Capability
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Ultra-Small Surface Mount Package**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: PowerDI®323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Polarity: Cathode Band
- Terminals: Finish – Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 e3
- Weight: 0.006 grams (Approximate)

Top View

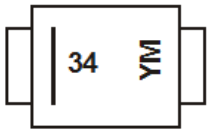
Bottom View

Ordering Information (Note 4)

Part Number	Case	Packaging
PD3S120L-7	PowerDI323	3,000/Tape & Reel

Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
2. See https://www.diodes.com/quality/lead-free/for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



34 = Product Type Marking Code
YM = Date Code Marking
Y = Year (ex: E = 2017)
M = Month (ex: 2 = Feb)

Date Code Key

Year	2004	2014	2015	2016	2017	2018	2019	2020	2021	2022	2023	2024
Code	R	B	C	D	E	F	G	H	I	J	K	L

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	20	V
RMS Reverse Voltage	$V_{R(RMS)}$	14	V
Average Forward Current (See Figure 6)	$I_{F(AV)}$	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I_{FSM}	33	A

Thermal Characteristics

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance Junction to Soldering Point	$R_{\theta JS}$	—	6	°C/W
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{\theta JA}$	170	—	°C/W
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{\theta JA}$	144	—	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +125		°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	20	—	—	V	I_R = 100µA
Forward Voltage	V_F	— — — —	0.27 0.34 0.36 0.27	0.31 0.38 0.42 0.30	V	I_F = 0.1A, T_A = +25°C I_F = 0.7A, T_A = +25°C I_F = 1.0A, T_A = +25°C I_F = 1.0A, T_A = +125°C
Leakage Current (Note 7)	I_R	—	10 13 30 11	50 60 160 30	µA µA µA mA	V_R = 5V, T_A = +25°C V_R = 10V, T_A = +25°C V_R = 20V, T_A = +25°C V_R = 20V, T_A = +125°C
Total Capacitance	C_T	—	46	—	pF	V_R = 10V, f = 1.0MHz

Notes:
5. FR-4 PCB, 2 oz. copper, minimum recommended pad layout per https://www.diodes.com/design/support/packaging/diodes-packaging/.
6. Polymide PCB, 2 oz. copper, minimum recommended pad layout per https://www.diodes.com/design/support/packaging/diodes-packaging/.
7. Short duration pulse test to minimize self-heating effect.

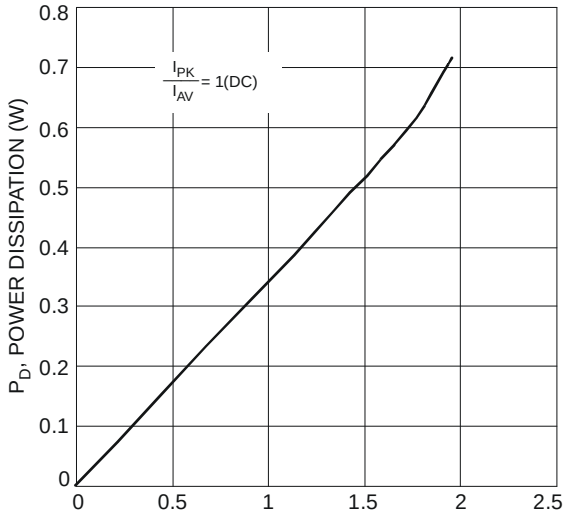


Fig. 1 Forward Power Dissipation

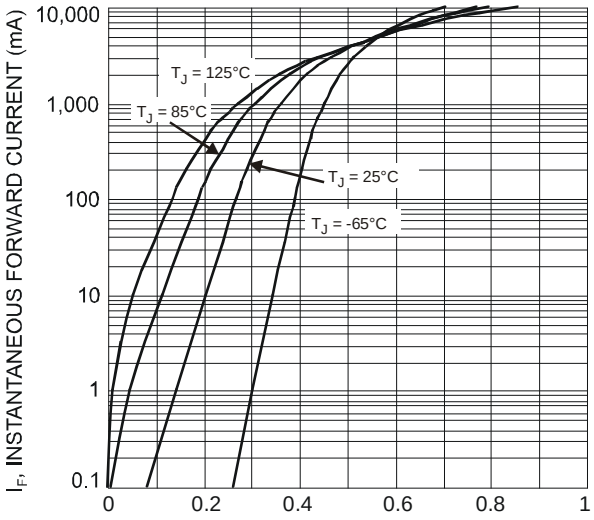


Fig. 2 Typical Forward Characteristics

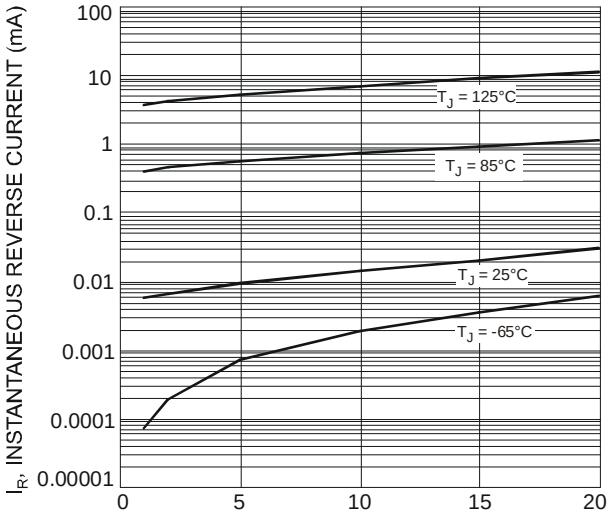


Fig. 3 Typical Reverse Characteristics

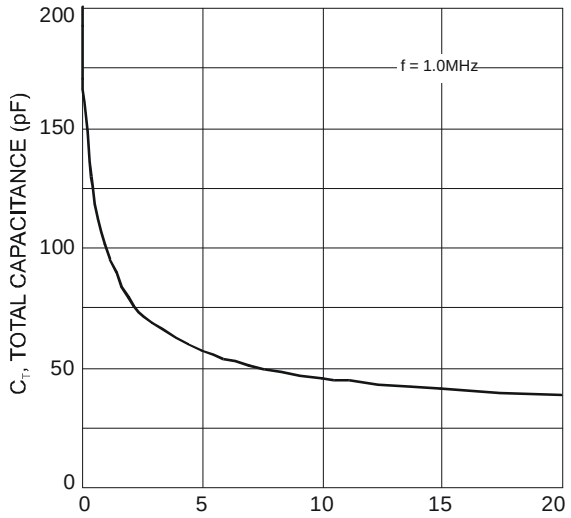


Fig. 4 Total Capacitance vs. Reverse Voltage

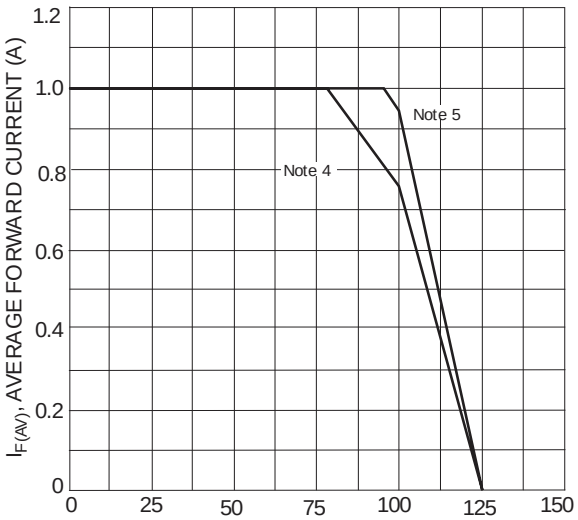


Fig. 5 Forward Current Derating Curve

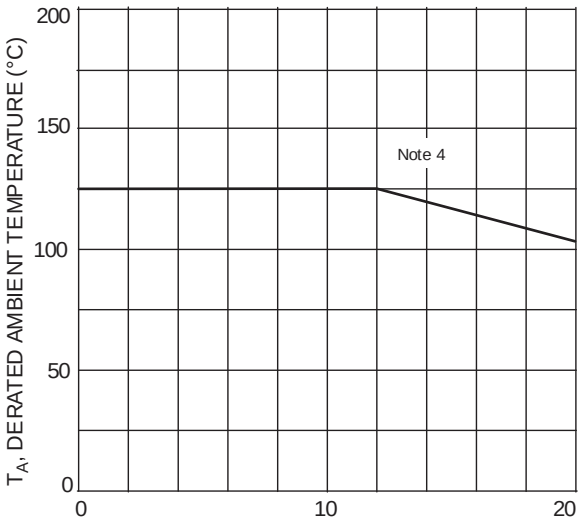
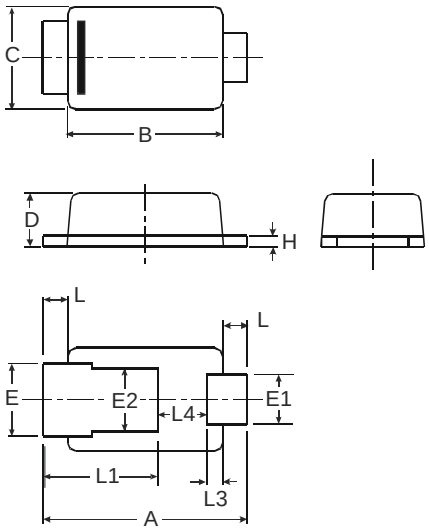


Fig. 6 Operating Temperature Derating

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI323

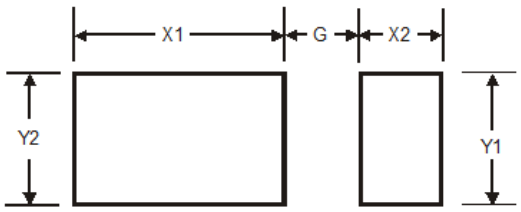


PowerDI323			
Dim	**Min**	**Max**	**Typ**
A	2.40	2.60	2.50
B	1.85	1.95	1.90
C	1.20	1.30	1.25
D	0.60	0.70	0.65
E	0.78	0.98	0.88
E1	0.50	0.70	0.60
E2	0.60	1.00	0.80
H	0.08	0.18	0.13
L	0.20	0.40	0.30
L1	-	-	1.40
L3	-	-	0.20
L4	0.40	0.80	0.60
All Dimensions in mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI323



Dimensions	Value (in mm)
G	0.5
X1	2.0
X2	0.8
Y1	0.8
Y2	1.1

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